

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6595729

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
DAICHI FUKUSHIMA	01/12/2021
HOUSEI MIZUNO	01/08/2021
MIYU ARAMAKI	01/08/2021
TETSUYA NISHIMURA	02/10/2021
RECEIVING PARTY DATA	
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Street Address:	1-14, NISHISUEHIRO-CHO, YOKKAICHI-SHI
City:	MIE
State/Country:	JAPAN
Postal Code:	5108503
Name:	SUMITOMO WIRING SYSTEMS, LTD.
Street Address:	1-14, NISHISUEHIRO-CHO, YOKKAICHI-SHI
City:	MIE
State/Country:	JAPAN
Postal Code:	5108503
Name:	SUMITOMO ELECTRIC INDUSTRIES, LTD.
Street Address:	5-33, KITAHAMA 4-CHOME, CHUO-KU, OSAKA-SHI
City:	OSAKA
State/Country:	JAPAN
Postal Code:	5410041
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17263302
CORRESPONDENCE DATA	
Fax Number:	(703)716-1180
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	7037161191
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Correspondent Name: GREENBLUM & BERNSTEIN P.L.C.
Address Line 1: 1950 ROLAND CLARKE PLACE
Address Line 4: RESTON, VIRGINIA 20191

ATTORNEY DOCKET NUMBER:	P62385
NAME OF SUBMITTER:	STEVEN B. POLLICOFF
SIGNATURE:	/Steven B. Pollicoff/
DATE SIGNED:	03/11/2021

Total Attachments: 14

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COMBINED INVENTOR'S DECLARATION AND ASSIGNMENT

DECLARATION

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Authorization to Permit Access to Application by Participating Office

☒ If checked, the undersigned hereby grants the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (JPO), the Korean Intellectual Property Office (KIPO), the World Intellectual Property Office (WIPO), and any other intellectual property offices in which a foreign application claiming priority to the above-identified patent application is filed access to the above-identified patent application. See 37 CFR 1.14(c) and (h). This box should not be checked if the applicant does not wish the EPO, JPO, KIPO, WIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified patent application is filed to have access to the above-identified patent application.

In accordance with 37 CFR 1.14(h)(3), access will be provided to a copy of the above-identified patent application with respect to: 1) the above-identified patent application-as-filed; 2) any foreign application to which the above-identified patent application claims priority under 35 U.S.C. 119(a)-(d) if a copy of the foreign application that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the above-identified patent application; and 3) any U.S. application-as-filed from which benefit is sought in the above-identified patent application.

In accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit Access to Application by Participating Offices.

Direct Correspondence to: **CUSTOMER NUMBER 07055**

At: Greenblum & Bernstein, P.L.C.
1950 Roland Clarke Place
Reston, VA 20191

Direct Telephone Calls to: Greenblum & Bernstein, P.L.C. (703) 716-1191

ASSIGNMENT

WHEREAS, **Daichi FUKUSHIMA**, a resident of Japan, whose mailing address is c/o AutoNetworks Technologies, Ltd., 1-14, Nishisuehiro-cho, Yokkaichi-shi, Mie 5108503, JAPAN, **Housei MIZUNO**, a resident of Japan, whose mailing address is c/o AutoNetworks Technologies, Ltd., 1-14, Nishisuehiro-cho, Yokkaichi-shi, Mie 5108503, JAPAN, **Miyu ARAMAKI**, a resident of Japan, whose mailing address is c/o AutoNetworks Technologies, Ltd., 1-14, Nishisuehiro-cho, Yokkaichi-shi, Mie 5108503, JAPAN, and **Tetsuya NISHIMURA**, a resident of Japan, whose mailing address is c/o Sumitomo Wiring Systems, Ltd., 1-14, Nishisuehiro-cho, Yokkaichi-shi, Mie 5108503, JAPAN, hereinafter referred to as the ASSIGNORS, have invented a certain improvement relating to

FIXING STRUCTURE OF SPLICE PART

for which they have jointly executed an application for Letters Patent of the United States to be filed in the United States Patent and Trademark Office.

If this Assignment is filed after the filing date of the above-identified application, the undersigned hereby authorize and request any one of the practitioners of record in this application associated with Customer No. 07055 including Neil F. Greenblum, Reg. No. 28,394, Bruce H. Bernstein, Reg. No. 29,027, Arnold Turk, Reg. No. 33,094, James L. Rowland, Reg. No. 32,674, Stephen M. Roylance, Reg. No. 31,296, Leslie J. Paperner, Reg. No. 33,329, William Pieprz, Reg. No. 33,630, Robert W. Mueller, Reg. No. 35,043, William E. Lyddane, Reg. No. 41,568 and William S. Boshnick, Reg. No. 44,550, of the firm Greenblum & Bernstein, P.L.C., whose address is 1950 Roland Clarke Place, Reston, Virginia 20191, to insert here in parenthesis (Application No. 17/263,302, filed 1/26/2021) the filing date and application number of said application when known.

AND WHEREAS, **AutoNetworks Technologies, Ltd.**, a corporation organized and existing under the laws of JAPAN, whose mailing address is 1-14, Nishisuehiro-cho, Yokkaichi-shi, Mie 5108503 JAPAN, **Sumitomo Wiring Systems, Ltd.**, a corporation organized and existing under the laws of JAPAN, whose mailing address is 1-14, Nishisuehiro-cho, Yokkaichi-shi, Mie 5108503 JAPAN, and **SUMITOMO ELECTRIC INDUSTRIES, LTD.**, a corporation organized and existing under the laws of JAPAN, whose mailing address is 5-33, Kitahama 4-chome, Chuo-ku, Osaka-shi, Osaka 5410041 JAPAN, hereinafter known as the ASSIGNEE, is desirous of acquiring the entire right, title and interest for the United States and elsewhere throughout the world in and to said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, reexaminations, and prolongations thereof.

NOW, THIS WITNESSETH that for good and valuable consideration, the receipt whereof is hereby acknowledged, said ASSIGNORS hereby assign, sell and transfer to said ASSIGNEE, its assigns and legal representatives, the entire and exclusive right, title and interest in and to said invention and application, for the United States and elsewhere throughout the world including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted

therefor and all rights to sue for past and future infringement thereunder, said ASSIGNEE and its assigns and legal representatives to have, hold, exercise and enjoy the said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, reexaminations and prolongations thereof, with all the rights, powers, privileges, and advantages in any ways arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues, reexaminations, and prolongations thereof, for the use and benefit of said ASSIGNEE and its assigns and legal representatives in as ample and beneficial a manner to all intents and purposes as the said ASSIGNORS might or could have held and enjoyed the same, if this assignment had not been made.

AND said ASSIGNORS hereby agree to execute all papers necessary to file applications in the United States and elsewhere throughout the world for said invention and to assign the same to said ASSIGNEE, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing Letters Patent thereon.

AND said ASSIGNORS authorize and request the Commissioner of Patents to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEE, its assigns and legal representatives, in accordance herewith.

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNORS, on the respective dates indicated below.

First Witness:

(Name)

(Date)

Daichi Fukushima
Daichi FUKUSHIMA

January 12, 2021
Date

Second Witness:

(Name)

(Date)

First Witness:

(Name)

(Date)

Housei Mizuno
Housei MIZUNO

January 8, 2021
Date

Second Witness:

(Name)

(Date)

First Witness:

(Name)

(Date)

Miyu Aramaki

Miyu ARAMAKI

January 8, 2021

Date

Second Witness:

(Name)

(Date)

First Witness:

(Name)

(Date)

Tetsuya NISHIMURA

Date

Second Witness:

(Name)

(Date)

COMBINED INVENTOR'S DECLARATION AND ASSIGNMENT**DECLARATION**

The herein-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Authorization to Permit Access to Application by Participating Office

☒ If checked, the undersigned hereby grants the USPTO authority to provide the European Patent Office (EPO), the Korean Intellectual Property Office (KIPO), the China National Intellectual Property Administration (CNIPA), the World Intellectual Property Office (WIPO), the Japanese Patent Office (JPO), and any other intellectual property offices in which a foreign application claiming priority to the herein-identified patent application is filed access to the herein-identified patent application. See 37 CFR 1.14(c) and (h). This box should not be checked if the applicant does not wish the EPO, KIPO, CNIPA, WIPO, JPO, or other intellectual property office in which a foreign application claiming priority to the herein-identified patent application is filed to have access to the herein-identified patent application.

In accordance with 37 CFR 1.14(h)(3), access will be provided to a copy of the herein-identified patent application with respect to: 1) the herein-identified patent application-as-filed; 2) any foreign application to which the herein-identified patent application claims priority under 35 U.S.C. 119(a)-(d) if a copy of the foreign application that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the herein-identified patent application; and 3) any U.S. application-as-filed from which benefit is sought in the herein-identified patent application.

In accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit Access to Application by Participating Offices.

The undersigned hereby authorizes the U.S. attorney or agent appointed herein to accept and follow instructions from either his foreign patent agent or corporate representative, if any, as to any action to be taken in the Patent and Trademark Office regarding this application without direct communication between the U.S. attorney or agent and the undersigned.

Direct Correspondence to: **CUSTOMER NUMBER 07055**

At: Greenblum & Bernstein, P.L.C.
1950 Roland Clarke Place
Reston, VA 20191

Direct Telephone Calls to: Greenblum & Bernstein, P.L.C. (703) 716-1191

ASSIGNMENT

WHEREAS, **Daichi FUKUSHIMA**, a resident of Mie, JAPAN, whose mailing address is c/o AutoNetworks Technologies, Ltd., 1-14, Nishisuehiro-cho, Yokkaichi-shi, Mie 5108503 JAPAN, **Housei MIZUNO**, a resident of Mie, JAPAN, whose mailing address is c/o AutoNetworks Technologies, Ltd., 1-14, Nishisuehiro-cho, Yokkaichi-shi, Mie 5108503 JAPAN, **Miyu ARAMAKI**, a resident of Mie, JAPAN, whose mailing address is c/o AutoNetworks Technologies, Ltd., 1-14, Nishisuehiro-cho, Yokkaichi-shi, Mie 5108503 JAPAN, and **Tetsuya NISHIMURA**, a resident of Mie, JAPAN, whose mailing address is c/o Sumitomo Wiring Systems, Ltd., 1-14, Nishisuehiro-cho, Yokkaichi-shi, Mie 5108503 JAPAN, hereinafter referred to as the ASSIGNORS, have invented a certain improvement relating to

FIXING STRUCTURE OF SPLICE PART

for which an application for Letters Patent in the United States entered the National Stage in the United States Patent and Trademark Office on January 26, 2021 and was awarded Application No. 17/263,302, and which Application is a National Stage of International Application No. PCT/JP2019/027655, filed July 12, 2019.

AND WHEREAS, **AutoNetworks Technologies, Ltd.**, a corporation organized and existing under the laws of JAPAN, whose mailing address is 1-14, Nishisuehiro-cho, Yokkaichi-shi, Mie 5108503 JAPAN, **Sumitomo Wiring Systems, Ltd.**, a corporation organized and existing under the laws of JAPAN, whose mailing address is 1-14, Nishisuehiro-cho, Yokkaichi-shi, Mie 5108503 JAPAN, and **SUMITOMO ELECTRIC INDUSTRIES, LTD.**, a corporation organized and existing under the laws of JAPAN, whose mailing address is 5-33, Kitahama 4-chome, Chuo-ku, Osaka-shi, Osaka 5410041 JAPAN, hereinafter known as the ASSIGNEES, are each desirous of acquiring an equal undivided interest in the entire right, title and interest for the United States in and to said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, reexaminations, and prolongations thereof.

NOW, THIS WITNESSETH that for good and valuable consideration, the receipt whereof is hereby acknowledged, said ASSIGNORS hereby assign, sell and transfer to said ASSIGNEES, their assigns and legal representatives, the entire and exclusive right, title and interest in and to said invention and application, for the United States including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted therefor and all rights to sue for past and future infringement thereunder, said ASSIGNEES and their assigns and legal representatives to have, hold, exercise and enjoy the said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, reexaminations, and prolongations thereof, with all the rights, powers, privileges, and advantages in any ways arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues, reexaminations, and prolongations thereof, for the use and benefit of said ASSIGNEES and their assigns and legal representatives in as ample and beneficial a manner to all intents and purposes as the said ASSIGNORS might or could have held and enjoyed the same, if this assignment had not been made.

AND said ASSIGNORS hereby agree to execute all papers necessary to file applications in the United States for said invention and to assign the same to said ASSIGNEES, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing Letters Patent thereon.

AND said ASSIGNORS authorize and request the Commissioner of Patents to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEES, their assigns and legal representatives, in accordance herewith.

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNOR(S), on the respective date(s) indicated below.

First Witness:

(Name)

(Date)

Daichi FUKUSHIMA

Date

Second Witness:

(Name)

(Date)

First Witness:

(Name)

(Date)

Housei MIZUNO

Date

Second Witness:

(Name)

(Date)

First Witness:

(Name)

(Date)

Miyu ARAMAKI

Date

Second Witness:

(Name)

(Date)

First Witness:

(Name)

(Date)

Tetsuya NISHIMURA
Tetsuya NISHIMURA

FEB. 10, 2021
Date

Second Witness:

(Name)

(Date)